



Glass Hybrid IC Package

General Information:

- 1: Material: Kovar, CRS1010, Alloy52
2. Option1 :
Au Plating 50 μ " min over 100 μ " nickel on pins only;
150 μ " nickel plated on the package
Option2:
Au plating 50 μ " min over 100 μ " nickel.
3. Precision machining

Typical Packages:

1. DIL/DIP package
2. Flat-packages
3. Platform packages
4. Customized Hybrid packages

